Photocouplers Photorelay

TLP171D

1. Applications

- Mechanical relay replacements
- Security Systems
- Modem/Fax PC Cards
- Private Branch Exchanges (PBXs)
- Measuring Instruments

2. General

The TLP171D photorelay consists of a photo MOSFET optically coupled to an infrared light emitting diode. It is housed in a 4-pin package with 2.54-mm lead pitch and 2.1-mm height. This photorelay requires 0.2 mA of LED current to turn it on. It is suitable for applications that need electrical power savings.

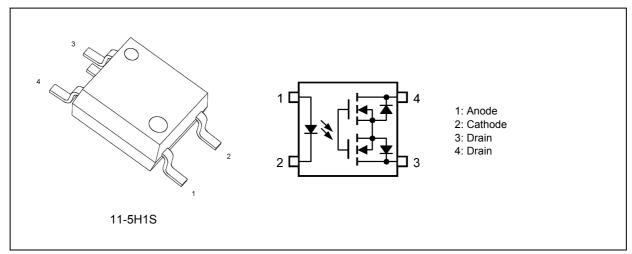
3. Features

- (1) Package: SOP(2.54SOP4) (Height 2.1 mm, pitch 2.54 mm)
- (2) Normally opened (1-Form-A)
- (3) OFF-state output terminal voltage: 200 V (min)
- (4) Trigger LED current: 0.1 mA (max)(t≤1s)

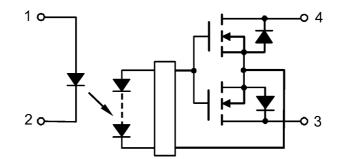
0.2 mA (max)(t > 1 s)

- (5) ON-state current: 200 mA (max)
- (6) ON-state resistance: 8Ω (max)
- (7) Isolation voltage: 1500 Vrms (min)
- (8) Safety Standards
 UL approved: UL1577, File No. E67349
 cUL approved: CSA Component Acceptance Service No. 5A File No.E67349

4. Packaging and Pin Assignment



5. Internal Circuit



6. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25$ °C)

	Characteristics		Symbol	Note	Rating	Unit
LED	Input forward current		١ _F		30	mA
	Input forward current derating	(T _a ≥ 25 °C)	$\Delta I_F / \Delta T_a$		-0.3	mA/°C
	Input forward current (pulsed)	(100 μs pulse, 100 pps)	I _{FP}		1	Α
	Input reverse voltage		V _R		5	V
	Input power dissipation		PD		50	mW
	Junction temperature		Tj		125	°C
Detector	OFF-state output terminal voltage	V _{OFF}		200	V	
	ON-state current	I _{ON}		200	mA	
	ON-state current derating	$(T_a \ge 25 \ ^\circ C)$	$\Delta I_{ON} / \Delta T_a$		-2.0	mA/°C
	ON-state current (pulsed)	(t = 100 ms)	I _{ONP}		600	mA
	Output power dissipation		Po		300	mW
	Junction temperature		Tj		125	°C
Common	Storage temperature		T _{stg}		-55 to 125	
	Operating temperature		T _{opr}		-40 to 85	
	Lead soldering temperature	(10 s)	T _{sol}		260	°C
	Isolation voltage	AC, 1 min, R.H. ≤ 60 %, T _a = 25 °C	BVS	(Note 1)	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

7. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Supply voltage	V _{DD}		—	—	160	V
Input forward current	١ _F		_	0.5	25	mA
ON-state current	I _{ON}		_	_	160	mA
Operating temperature	T _{opr}		-20		65	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this datasheet should also be considered.

8. Electrical Characteristics (Unless otherwise specified, $T_a = 25$ °C)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V _F		I _F = 10 mA	1.1	1.27	1.4	V
	Input reverse current	I _R		V _R = 5 V	_	—	10	μA
	Input capacitance	Ct		V = 0 V, f = 1 MHz	_	30	_	pF
Detector	OFF-state current	I _{OFF}		V _{OFF} = 200 V	_	1	1000	nA
	Output capacitance	C _{OFF}		V = 0 V, f = 1 MHz	_	90	_	pF

9. Coupled Electrical Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}		I _{ON} = 200 mA, t≤1s	_	0.02	0.1	mA
			I _{ON} = 200 mA, t>1s	_	_	0.2	mA
Return LED current	I _{FC}		I _{OFF} = 100 μA		0.001	—	mA
ON-state resistance	R _{ON}		I_{ON} = 200 mA, I_F = 0.5 mA, t < 1 s	_	5	8	Ω

10. Isolation Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	Cs	(Note 1)	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	R _S	(Note 1)	V_S = 500 V, R.H. \leq 60 %	$5 imes 10^{10}$	10 ¹⁴	_	Ω
Isolation voltage	BVS	(Note 1)	AC, 1 min	1500	_	—	Vrms
			AC, 1s in oil	—	3000	_	
			DC, 1 min, in oil	_	3000	_	Vdc

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

11. Switching Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t _{ON}		See Fig. 11.1. $R_L = 200 \Omega$, $V_{DD} = 20 V$, $I_F = 0.5 mA$	_	3.5	10	ms
			See Fig. 11.1. R _L = 200 Ω, V _{DD} = 20 V, I _F = 1.0 mA		1.5	5	
Turn-off time	t _{OFF}		See Fig. 11.1. R _L = 200 Ω, V _{DD} = 20 V, I _F = 0.5 mA	_	1	5	
			See Fig. 11.1. R _L = 200 Ω, V _{DD} = 20 V, I _F = 1.0 mA		1	5	

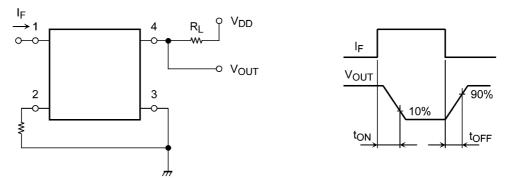
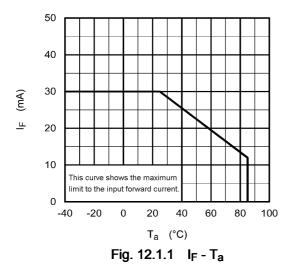
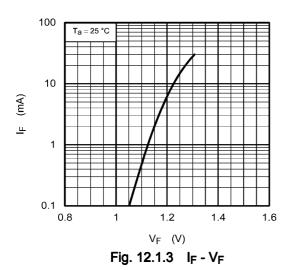


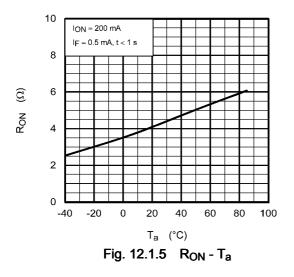
Fig. 11.1 Switching Time Test Circuit

12. Characteristics Curves

12.1. Characteristics Curves (Note)







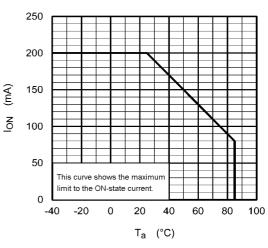
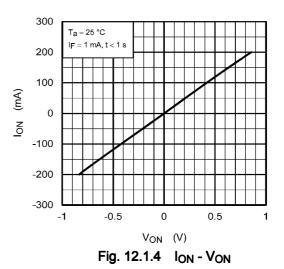
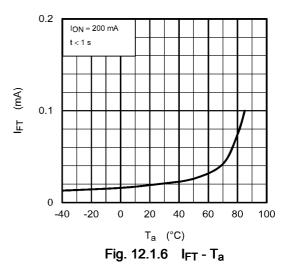
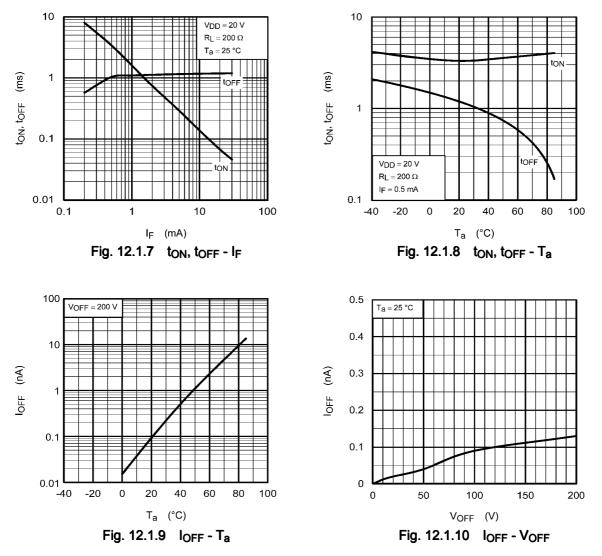


Fig. 12.1.2 I_{ON} - T_a







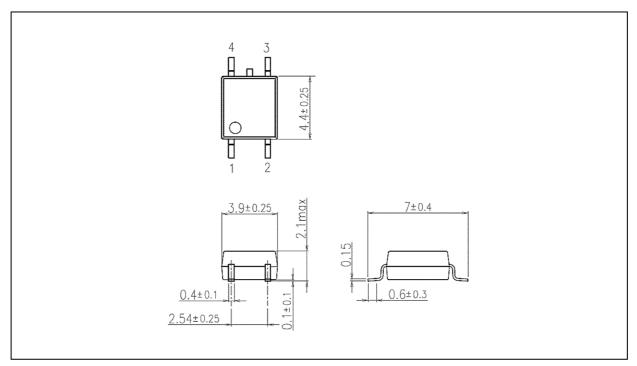
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



TLP171D

Package Dimensions

Unit: mm



Weight: 0.1 g (typ.)

	Package Name(s)
TOSHIBA: 11-5H1S	

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